

Vishay Siliconix

N-Channel 40 V (D-S) MOSFET



PRODUCT SUMMARY			
V _{DS} (V)	40		
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 10 \text{ V}$	0.00179		
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 4.5 \text{ V}$	0.00236		
Q _g typ. (nC)	130		
I _D (A)	150 ^d		
Configuration	Single		

FEATURES

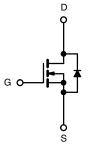
- TrenchFET® power MOSFET
- Maximum 175 °C junction temperature



- Excellent R_{DS}-Q_q and R_{DS}-Q_{oss} FOM reduce power loss from conduction and switching to enable high efficiency
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Power supply
 - Secondary synchronous rectification
- DC/DC converter
- Power tools
- · Motor drive switch
- · Battery management



N-Channel MOSFET

ORDERING INFORMATION	
Package	TO-220
Lead (Pb)-free and halogen-free	SUP40012EL-GE3

PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage		V _{DS}	40	V	
Gate-source voltage		V _{GS}	± 20	v	
Continuous drain current (T _J = 150 °C)	T _C = 25 °C		150 ^d		
	T _C = 70 °C	l _D	150 ^d		
Pulsed drain current (t = 100 μs)		I _{DM}	300	A	
Avalanche current		I _{AS}	50		
Single avalanche energy ^a	L = 0.1 mH	E _{AS}	125	mJ	
Mandana and address of the state of the stat	T _C = 25 °C	PD	150 b	W	
Maximum power dissipation ^a	T _C = 125 °C		50 b		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	LIMIT	UNIT		
Junction-to-ambient (PCB mount) ^c	R _{thJA}	40	°C/W		
Junction-to-case (drain)	R _{thJC}	1			

- a. Duty cycle ≤ 1 %
- b. See SOA curve for voltage derating
- c. When mounted on 1" square PCB (FR4 material)
- d. Package limited



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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	40	-	-	V
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1	-	2.5	
Gate-body leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 250	nA
Zero gate voltage drain current		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μΑ
	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V, T _J = 125 °C	-	-	150	
		V _{DS} = 30 V, V _{GS} = 0 V, T _J = 175 °C	-	-	5	mA
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	120	-	-	Α
Police and the state of the sta	В	V _{GS} = 10 V, I _D = 30 A	-	0.00149	0.00179	Ω
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 20 A	-	0.00196	0.00236	
Forward transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 30 A	-	230	-	S
Dynamic ^b						
Input capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 20 V, f = 1 MHz	-	10 930	-	pF
Output capacitance	C _{oss}		-	2041	-	
Reverse transfer capacitance	C _{rss}		-	101	-	
Total gate charge ^c	Qg	-	-	130	195	nC
Gate-source charge ^c	Q _{gs}		-	33.6	-	
Gate-drain charge ^c	Q_{gd}		-	6.7	-	
Output charge	Q _{oss}		-	64	96	
Gate resistance	R _g	f = 1 MHz	0.36	1.8	3.6	Ω
Turn-on delay time ^c	t _{d(on)}	$V_{DD} = 20 \text{ V}, \text{ R}_L = 2 \Omega$ $I_D \cong 10 \text{ A}, \text{ V}_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega$	-	25	50	
Rise time ^c	t _r		-	12	24	
Turn-off delay time ^c	t _{d(off)}		-	65	130	ns
Fall time ^c	t _f		-	18	36	
Drain-Source Body Diode Ratings	and Characte	ristics ^b (T _C = 25 °C)				
Pulsed current (t = 100 μs)	I _{SM}		-	-	300	Α
Forward voltage ^a	V_{SD}	I _F = 10 A, V _{GS} = 0 V	-	0.8	1.5	V
Reverse recovery time	t _{rr}	I _F = 10 A, di/dt = 100 A/μs	-	58	116	ns
Peak reverse recovery charge	I _{RM(REC)}		-	2.1	4.2	Α
Reverse recovery charge	Q _{rr}		-	72	144	nC
Reverse recovery fall time	t _a		-	32	-	20
Reverse recovery rise time	t _b		-	26	-	ns

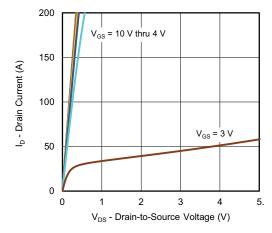
Notes

- a. Pulse test; pulse width $\leq 300~\mu\text{s},$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

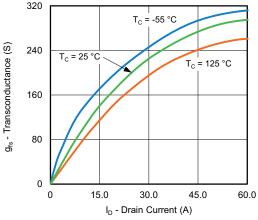
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



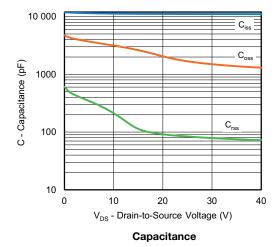
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

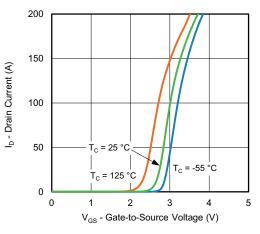


Output Characteristics

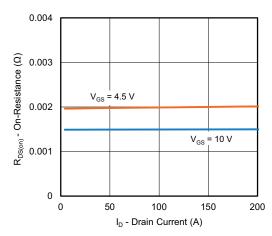


Transconductance

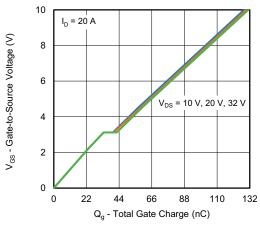




Transfer Characteristics



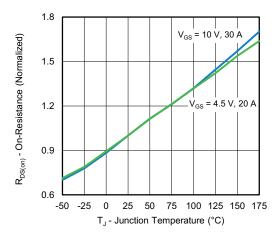
On-Resistance vs. Drain Current



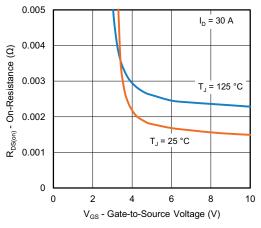
Gate Charge



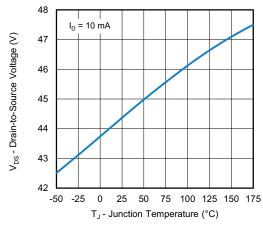
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



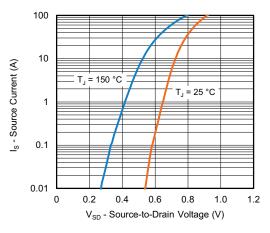
On-Resistance vs. Junction Temperature



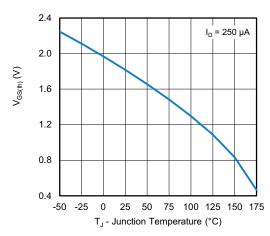
On-Resistance vs. Gate-to-Source Voltage



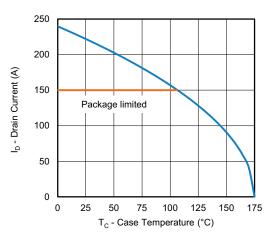
Drain Source Breakdown vs. Junction Temperature



Source Drain Diode Forward Voltage



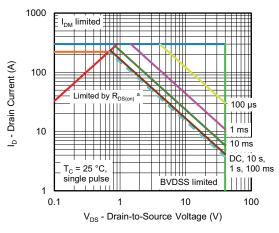
Threshold Voltage

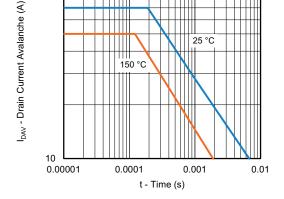


Current De-rating



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)





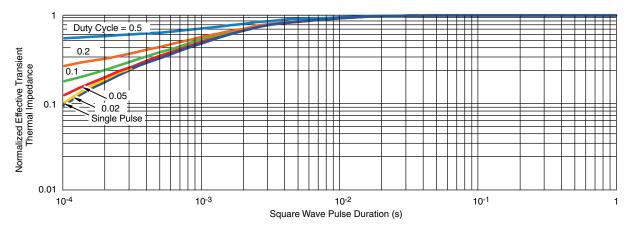
100

Safe Operating Area

Single Pulse Avalanche Current Capability vs. Time

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction to Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction to Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual pplication parameters and operating conditions

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